

# SSC8340GN4

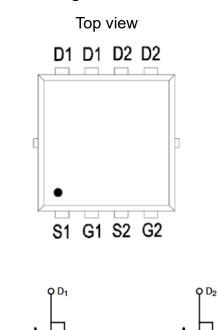
## **Dual N-Channel Enhancement MOSFET**

> Features

VDS	VGS	RDSON Typ.	ID
401/	1201/	21mR@10V	454
40V	±20V	25mR@4V5	15A

# > Description

SSC8340GN4 uses advanced trench technology to provide excellent RDSON and low gate charge. The complementary MOSFETS may be used to form a level shifted high side switch, and for a host of other applications.



**Pin configuration** 

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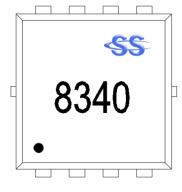


# Applications

- Inverter
- DC-DC converter
- Half and Full Bridge Topology
- Wireless Charging

## > Ordering Information

Device	Package	Shipping
SSC8340GN4	PDFN3.3X3.3	5000/Reel



Marking



### > Absolute Maximum Ratings(T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage		40	V
V <sub>GSS</sub>	Gate-to-Source Voltage		±20	V
I-	Continuous Drain	TC=25℃	15	A
Ι <sub>D</sub>	Current <sup>d</sup>	<b>TC=100</b> ℃	10	А
I <sub>DM</sub>	Pulsed Drain Current <sup>b</sup>		60	A
I <sub>AS</sub>	Avalanche Current <sup>b</sup> L=0.1mH		23	A
E <sub>AS</sub>	Avalanche Energy <sup>b</sup> L=0.1mH		26	mJ
I	Continuous Drain	TA=25℃	8	A
ID	Current <sup>a</sup>	<b>TA=70</b> ℃	6.5	A
Р	Power Dissipation <sup>c</sup>	TC=25℃	10	W
P <sub>D</sub>		TC=100℃	4.1	W
		TA=25℃	2.1	W
P <sub>DSM</sub>	Power Dissipation <sup>a</sup>	<b>TA=70</b> ℃	1.3	W
TJ	Operation junction temperature		-55 to 150	°C
T <sub>STG</sub>	Storage temperature range		-55 to 150	°C

#### > Thermal Resistance Ratings ( $T_A=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
Reja	Junction-to-Ambient Thermal Resistance <sup>a</sup>	60	°C AM
Rejc	Junction-to-Case Thermal Resistance	12	°C/W

Note:

- a. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper,in a still air environment with T<sub>A</sub>=25°C.The value in any given application depends on the user is specific board design. The current rating is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation  $P_D$  is based on  $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

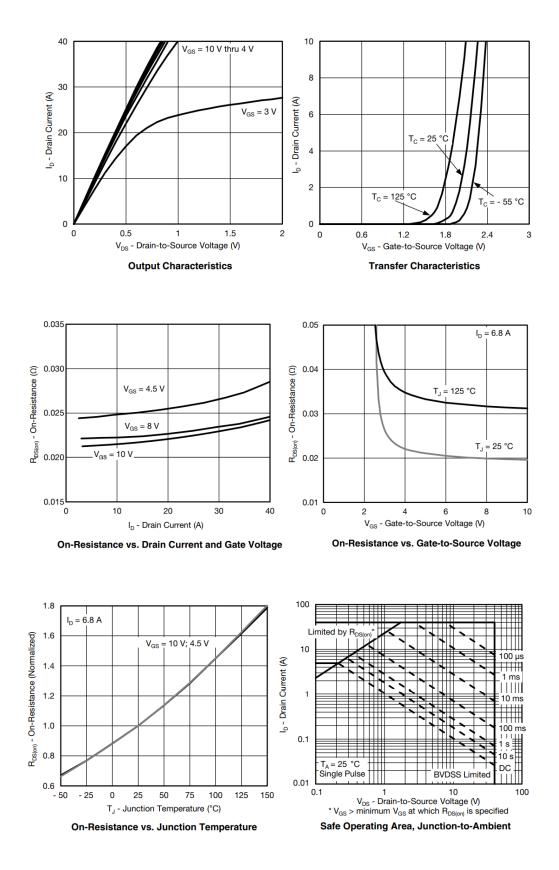


# Electronics Characteristics(T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Unit
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	VGS=0V , ID=250uA	40			V
$V_{GS\ (th)}$	Gate Threshold Voltage	VDS=VGS , ID=250uA	1	1.6	2	V
<b>D</b>	Drain-Source On-	VGS=10V , ID=10A		21	25	
$R_{DS(on)}$	Resistance	VGS=4.5V , ID=8A		25	30	- mR
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	VDS=32V, VGS=0V			1	uA
I <sub>GSS</sub>	Gate-Source leak current	VGS=±20V , VDS=0V			±100	nA
$G_{\text{FS}}$	Transconductance	VDS=5V , ID=10A		11		S
V <sub>SD</sub>	Forward Voltage	VGS=0V , IS=5A		0.8	1.3	V
Rg	Gate Resistance	VGS=0V, f=1MHZ		3		R
Ciss	Input Capacitance			815		
Coss	Output Capacitance	VDS=20V, VGS=0V,		151		
Crss	Reverse Transfer Capacitance	f=1MHZ		41		рF
Qg	Total Gate Charge			14		
Qgs	Gate Source Charge	VDS=20V, VGS=10V,		3		nC
Qgd	Gate Drain Charge	ID=10A		2		
T <sub>D(ON)</sub>	Turn-on delay time			6		
Tr	Rise time	VDS=20V, VGS=10V,		10		
T <sub>D(OFF)</sub>	Turn-off delay time	RL=3.7R, RG=1R		16		ns
Tf	Fall time			7		
Qrr	Diode Recovery Time	IF=5A , di/dt=100A/us		17		nC
Trr	Diode Recovery Charge	IF=5A , di/dt=100A/us		10		ns

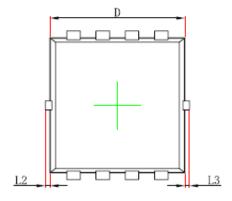


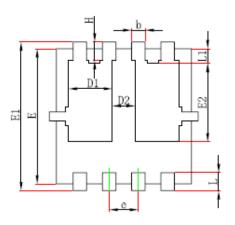
#### > **N-Channel Typical Characteristics**(T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)





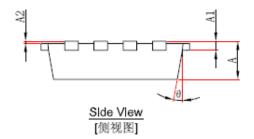
## Package Information





<u>Top Vlew</u> [顶视图]





Symbol	Dimensions In Millimeters		Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
А	0.650	0.850	0.026	0.033		
A1	0.152	REF.	0.006	REF.		
A2	0~0	0.05	0~0.002			
D	2.900	3.100	0.114	0.122		
D1	0.935	1.135	0.037	0.045		
D2	0.280	0.480	0.011	0.019		
E	2.900	3.100	0.114	0.122		
E1	3.150	3.450	0.124	0.136		
E2	1.535	1.935	0.060	0.076		
b	0.200	0.400	0.008	0.016		
e	0.550	0.750	0.022	0.030		
L	0.300	0.500	0.012	0.020		
L1	0.180	0.480	0.007	0.019		
L2	0~0.100		0~0	0~0.004		
L3	0~0.100		0~0.004			
Н	0.315	0.515	0.012	0.020		
θ	9°	13°	9°	13°		

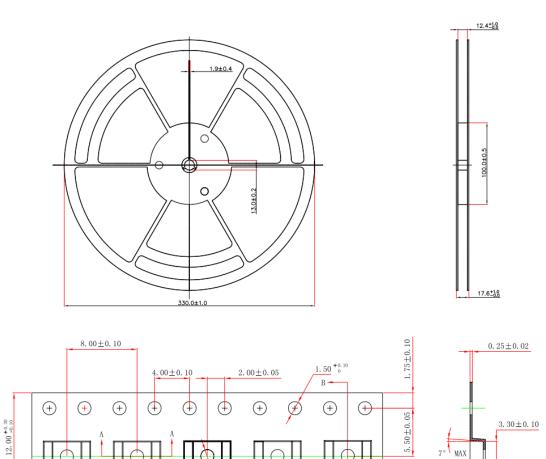


7° MAX

1.50±0.10

В-В

**Tape and Reel Data**  $\triangleright$ 



(

3.20

5.20±0.10

A-A

1.20

8° MAX

1.  $50_{-0}^{+0.25}$ 

В



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